

SUGGESTED PCB LAYOUT  
TOP VIEW

NOTES:

1. MATERIALS:

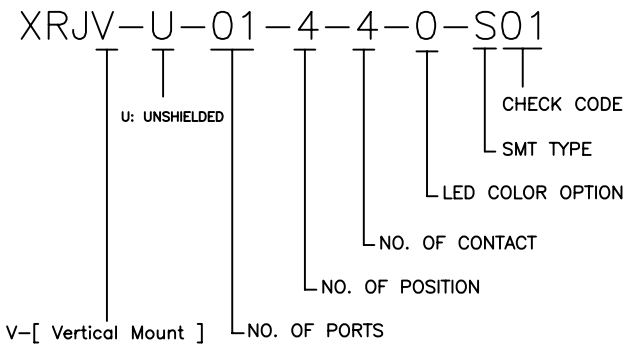
HOUSING-DSM STANYL TE250F6 (NYLON-46)  
HEAT DEFLECTION TEMP.290°  
BLACK COLOR, UL 94V-0

TERMINAL -0.35mm THICK PHOS-BRONZE  
PLATED WITH 30u" GOLD AND  
GOLD FLASH IN SOLDER AREA.

HOLD DOWN-0.35mm THICK COPPER ALLOY,  
PLATED WITH TIN.

2. CAVITY CONFORMS TO FCC RULES AND REGULATIONS  
PART 68,SUBPART F.

3. UNSPECIFIED TOLERANCE: .XX ±0.25[0.010]  
.X ±0.30[0.012]



NOTE:

1. A AND B HIGHEST POINT  
MUST OVER C FLAT SURFACE.
2. THE MAXIMUM DISTANCE (0.15m/m)  
BETWEEN LOWEST AND HIGHEST  
ON A AND B FLAT SURFACE.

RoHS Compliant

X MULTIPLE		THE INFORMATION AGE	
XMULTIPLE ASIA 4F, No. 347, Yang Guang St., Neihu Chiu, Taipei, Taiwan 11475	XMULTIPLE USA 1420 Los Angeles Ave., Suite G, Simi Valley, CA 93065	G/NO: 973B	DWG NO: XRJV-U-01-4-4-0-S01
THIS DRAWING IS A CONTROLLED DOCUMENT.			
TITLE: RJ11 Jack, W/o LED, 4P,4C, Unshielded, Vertical Mount, SMT		DRAWN: RUNES	
PART NO: XRJV-U-01-4-4-0-S01		CHKD: JEFF	
	UNIT mm[inch]	SHEET 1 of 1	REV 02
		DATE: Oct.27,06	